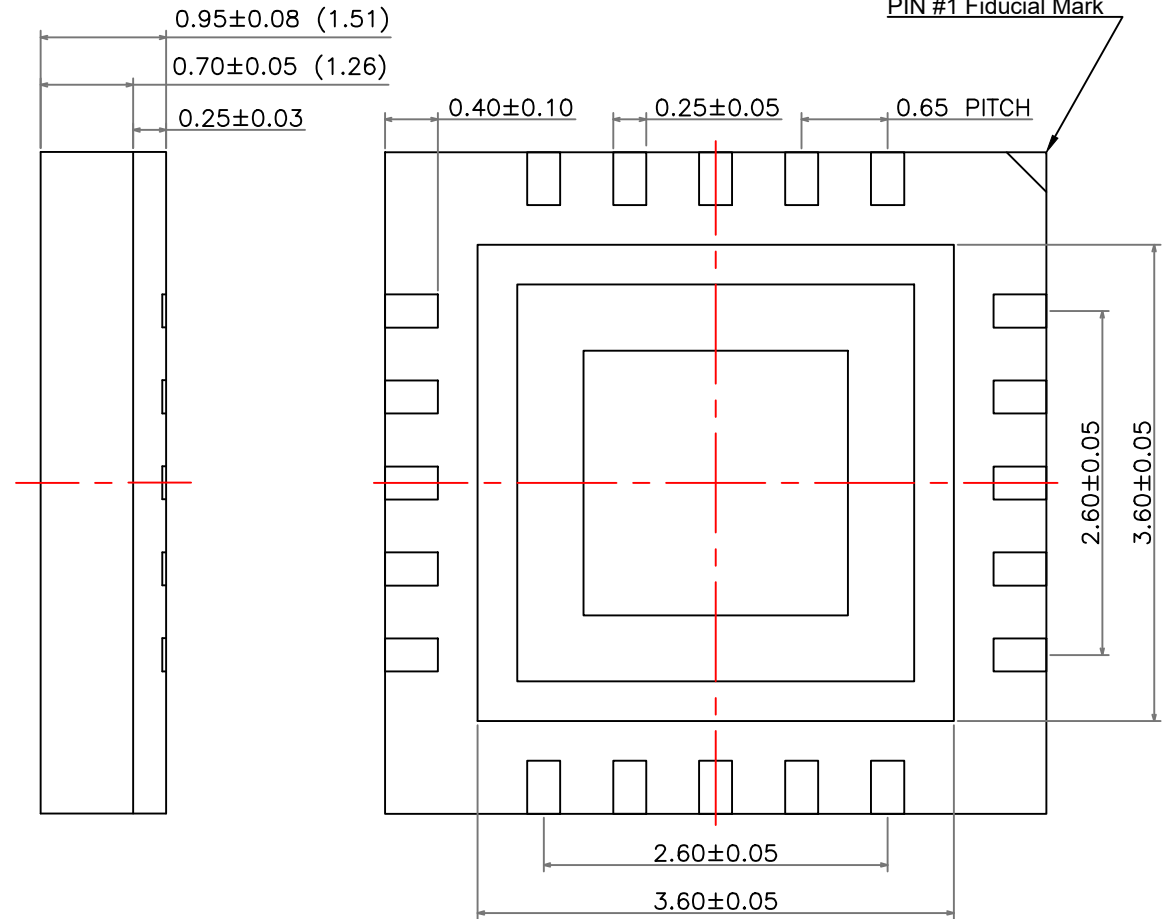


TOP VIEW



SIDE VIEW

BOTTOM VIEW

NOTES :

1. DRAWING CONFORM TO JEDEC
2. ALL DIMENSIONS ARE IN MILLIMETERS
3. SOLDERABLE EXPOSED PAD : 3.60 X 3.60 MM
4. DIMENSIONING AND TOLERANCING PER JEDEC
5. DIVERSIFICATION OF THE PKG OUTLINE IS POSSIBLE AS A LAND RADIAL TYPE

DESIGNED BY	CHECKED BY	CHECK BY	APPROVED BY	TITLE		
K.S.YUN				PKG OUTLINE DIMENSION MLQFN 20LD 5x5mm		
10/01/2023						
S N P T (Semiconductor And Packaging Testing Corporation)				UNIT	TOLERANCE	SCALE
				MM	-	1:1
				DWG NO.	SPEC NO.	SHEET
				POD-MLQFN-0520	MLQFN-06	1 OF 1